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March 2015

FDD86102LZ

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 35 A, 22.5 m Ω

Features

- Shielded Gate MOSFET Technology
- Max r_{DS(on)} = 22.5 mΩ at V_{GS} = 10 V, I_D = 8 A
- Max $r_{DS(on)}$ = 31 m Ω at V_{GS} = 4.5 V, I_D = 7 A
- HBM ESD protection level > 6 kV typical (Note 4)
- Very low Qg and Qgd compared to competing trench technologies
- Fast switching speed
- 100% UIL tested
- RoHS Compliant

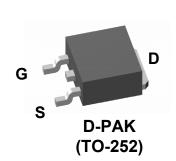


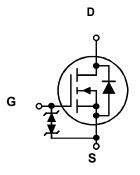
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

- DC DC Conversion
- Inverter
- Synchronous Rectifier





MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T _C = 25 °C		35		
	-Continuous	T _A = 25 °C	(Note 1a)	8	Α	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ	
P _D	Power Dissipation	T _C = 25 °C		54	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.1	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

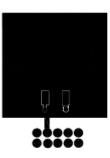
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 40	C/VV

Package Marking and Ordering Information

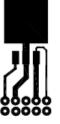
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86102LZ	FDD86102LZ	D-PAK(TO-252)	13 "	16 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V	
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		69		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±10	μA	
On Chara	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.5	3.0	V	
$\Delta V_{GS(th)} \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-6		mV/°C	
-	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 8 A		17.8	22.5		
r _{DS(on)}		V _{GS} = 4.5 V, I _D = 7 A		23.2	31	mΩ	
()		V_{GS} = 10 V, I _D = 8 A, T _J = 125 °C		31.1	40	-	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 8 A		31		S	
C _{iss}	Characteristics Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V,		1157	1540	pF	
C _{oss}	Output Capacitance	f = 1 MHz		181	245	pF	
C _{rss}	Reverse Transfer Capacitance			7.7	15	pF	
R _g	Gate Resistance			0.6		Ω	
Switching	J Characteristics						
t _{d(on)}	Turn-On Delay Time			6.6	14	ns	
t _r	Rise Time	V _{DD} = 50 V, I _D = 8 A,		2.3	10	ns	
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		20	32	ns	
t _f	Fall Time			2.3	10	ns	
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		18	26	nC	
Qg	Total Gate Charge	V_{GS} = 0 V to 4.5 V V_{DD} = 50 V,		8.7	13	nC	
Q _{gs}	Gate to Source Gate Charge	I _D = 8 A		2.7		nC	
Q _{gd}	Gate to Drain "Miller" Charge			2.4		nC	
Drain-Soເ	Irce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 8 A$ (Note 2)		0.82	1.3	V	
		$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.75	1.2		
t _{rr}	Reverse Recovery Time			43	70	ns	
Q _{rr}	Reverse Recovery Charge	— I _F = 8 A, di/dt = 100 A/μs		43	70	nC	

1. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.



a. 40 °C/W when mounted on a 1 in² pad of 2 oz copper.



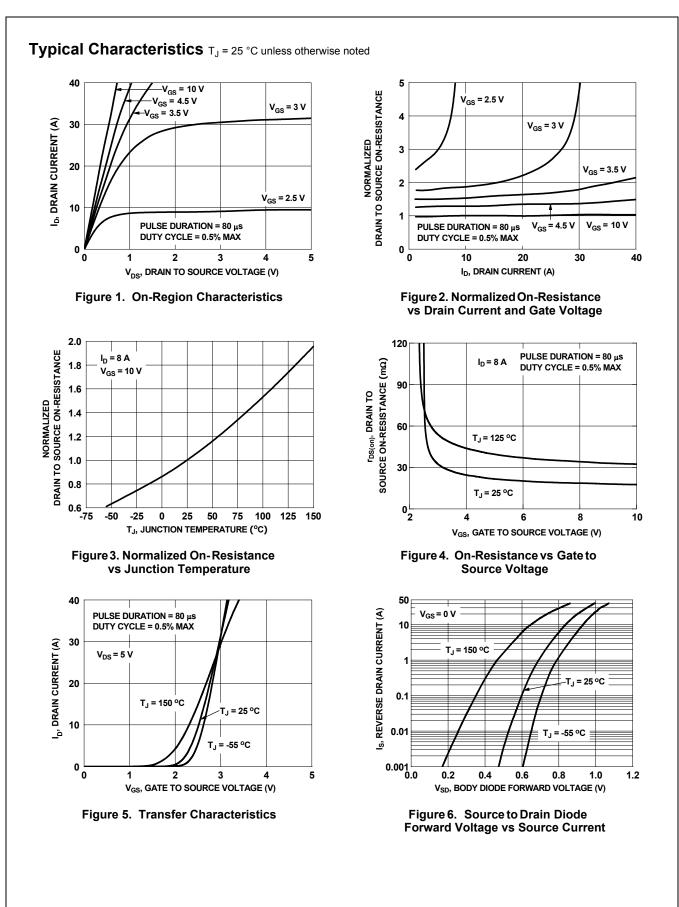
b. 96 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

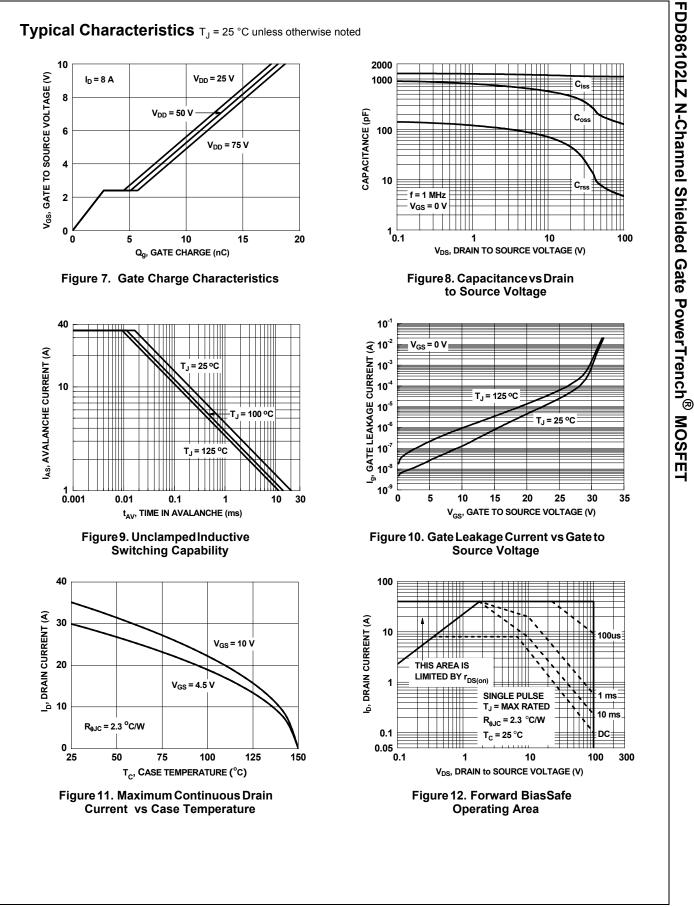
3. Starting T_J = 25°C, L = 1 mH, I_{AS} = 13 A, V_{DD} = 90 V, V_{GS} = 10 V.

4. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

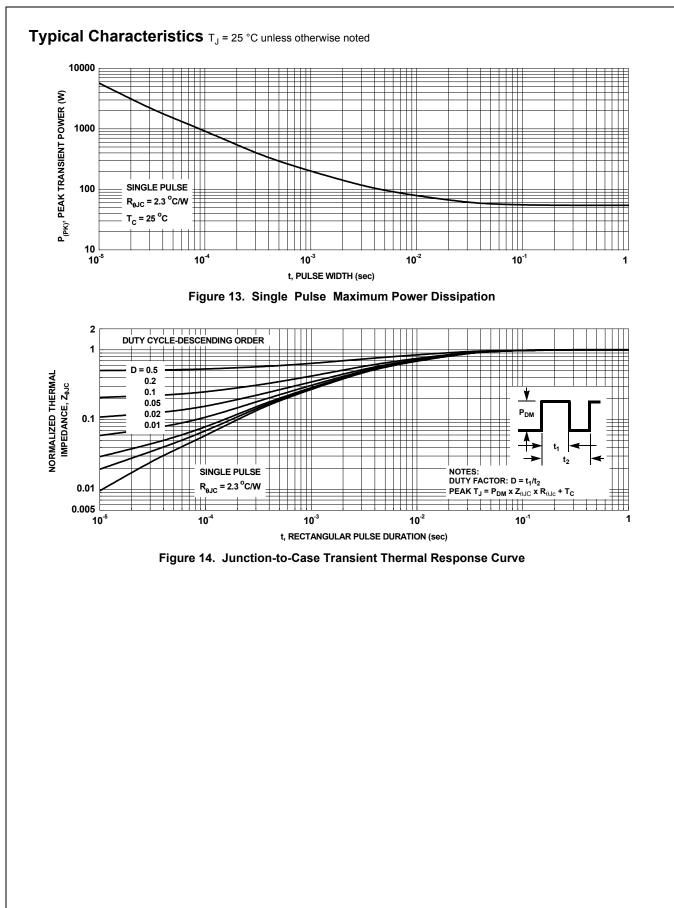
FDD86102LZ N-Channel Shielded Gate PowerTrench[®] MOSFET



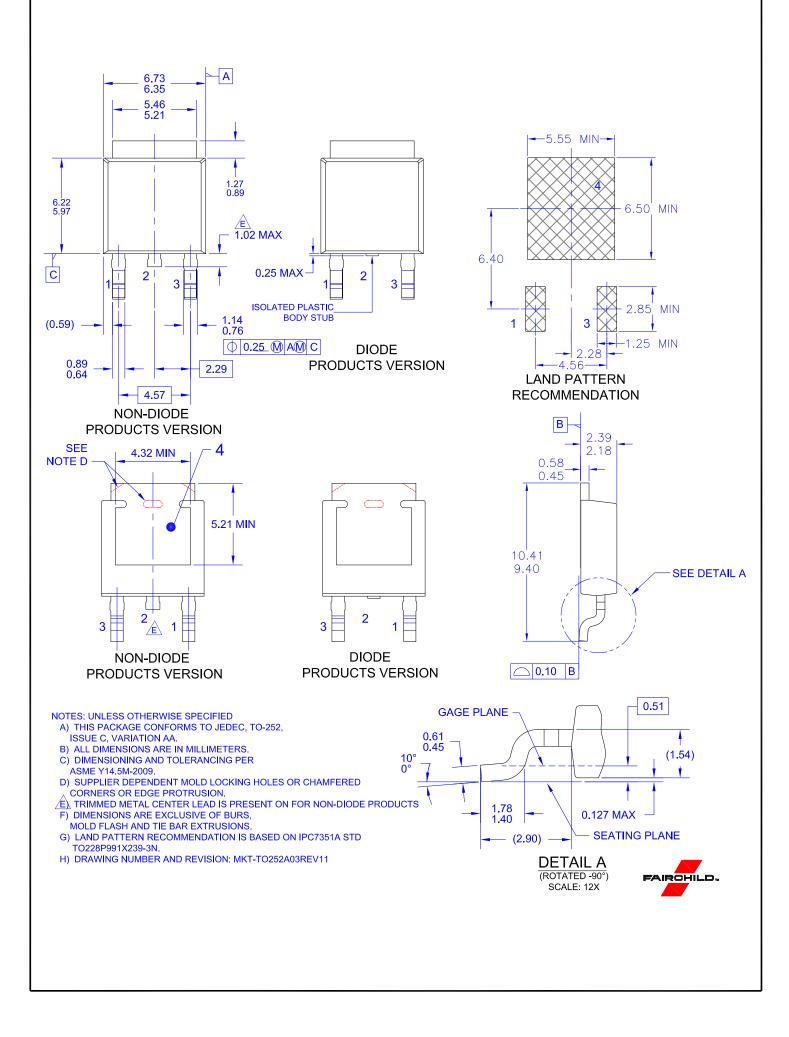
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FDD86102LZ N-Channel Shielded Gate PowerTrench[®] MOSFET



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